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NCP392C

Adjustable Front End Overvoltage Protection Controller with Protected Vbus Output

The NCP392C is an overvoltage front end protection controller and is able to disconnect the systems from its output pin in case wrong input operating conditions are detected, up to +28 V. Thanks to this device using internal NMOS, no external device is necessary, reducing the system cost and the PCB area of the application board.

Internal OVLO threshold is available, or can be adjusted if an external resistor bridge is used.

At power up ($\overline{EN}$ pin = low level), the Vout turns on tstart time after internal timer elapsed.

The NCP392C features an $\overline{ACOK}$ pin that indicates faulty condition.

Features

- Over−voltage Protection Up to + 28 V
- On−chip Low $R_{DS(on)}$ NMOS Transistors: Typical 34 mΩ
- Over−voltage Lockout (OVLO)
- Externally Adjustable OVLO
- Internal 15 ms Startup Delay
- Shutdown $\overline{EN}$ Input
- $\overline{ACOK}$ Status Pin
- + 100 V Surge Capability, in Compliance with IEC61000−4−5 Standard
- Compliance to IEC61000−4−2 (Level 4) Standard
  8 kV (Contact)
  15 kV (Air)
- ESD Ratings:
  Machine Model = B (200 V)
  Human Body Model = 2 (2 kV)
- CSP−12 Package 1.3 x 2.0 mm, 0.4 mm Pitch
- This is a Pb−Free Device

Typical Applications

- Cell Phones
- Tablets
- Camera Phones
- Digital Still Cameras
- Personal Digital Applications

ON Semiconductor®

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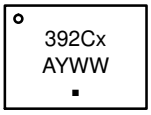
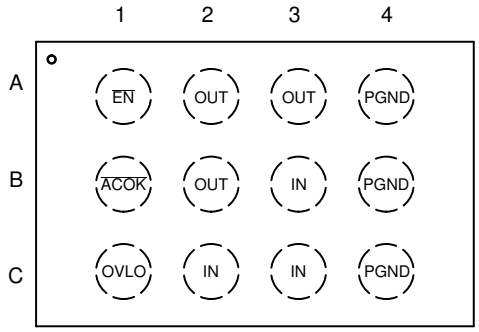
WLCSP 12
FCC SUFFIX
CASE 567JM

MARKING DIAGRAM



392Cx = Specific Device Number
(x = R or S)
A = Assembly Location
Y = Year
WW = Work Week
▪ = Pb−Free Package

PIN CONNECTION



(Top View)

ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 9 of this data sheet.

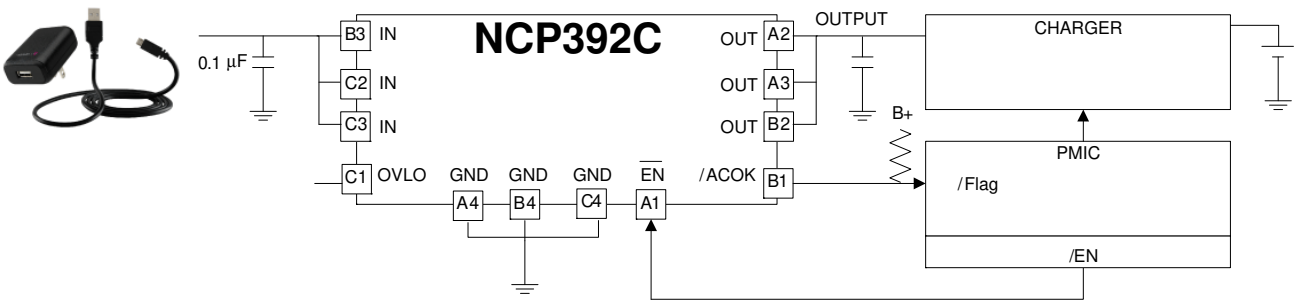


Figure 1. Typical Application Circuit

FUNCTIONAL BLOCK DIAGRAM

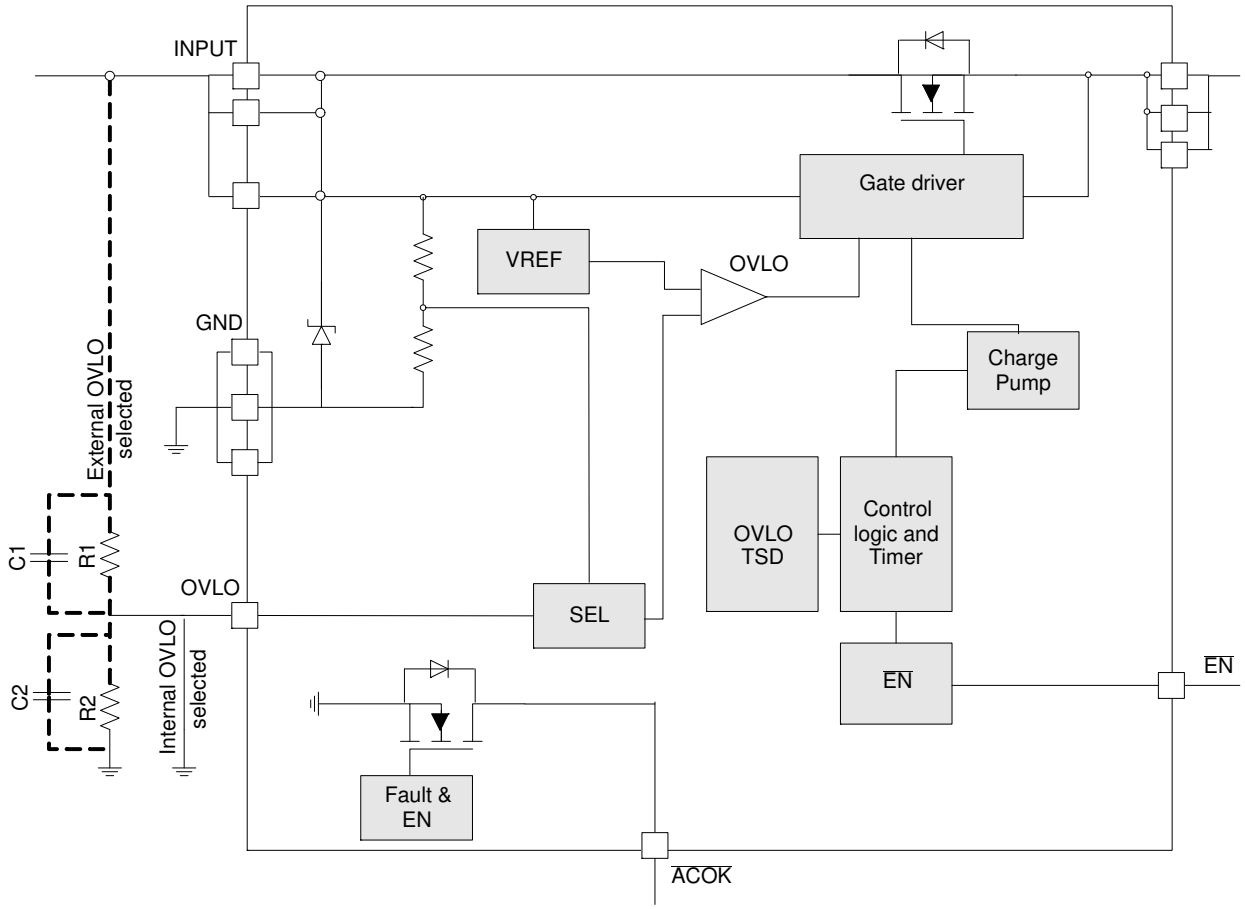
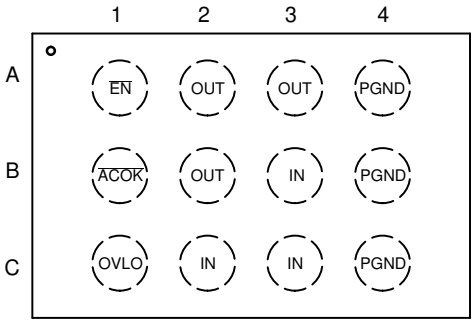


Figure 2. Functional Block Diagram

PIN FUNCTION DESCRIPTION



(Top View)

Figure 3. Pinout

Table 1. NCP392 PIN DESCRIPTION

Pin	Pin Name	Type	Description		
A1	$\overline{EN}$	I/O	Enable pin bar. The device enters in shutdown mode when this pin is tied to a high level. In this case the output is disconnected from the input.		
A2, A3, B2	OUT	OUTPUT	Output voltage pins. These pins follow IN pins, with debounce time, when “no fault” are detected. The outputs are disconnected from the Vin power supply when the input voltage is below UVLO, above OVLO threshold or internal thermal protection is exceeded. The three OUT pins must be hardwired together and used for power dissipation.		
A4, B4, C4	PGND	POWER	Ground. The three GND pins must be hardwired together and connect to the system GND.		
B1	$\overline{ACOK}$	OUTPUT	$\overline{ACOK}$ pin: fault indication pin. Open drain. This pied in tied low if Vin is within UVLO and OVLO range.	1	$V_{IN} < V_{UVLO}$ or $V_{IN} \geq V_{OVLO}$
				0	Voltage stable
B3, C2, C3	IN	POWER	Input voltage pins. These pins are connected to the power supply. The three IN pins must be hardwired together.		
C1	OVLO	INPUT	External OVLO Adjustment. Connect external resistor bridge to OVLO pin to select a different OVLO threshold. Connect OVLO pin to GND if not used. In this case internal OVLO will be selected.		

Table 2. MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Minimum Voltage (IN, OVLO to GND)	$Vmin_{IN}$	−0.3	V
Minimum Voltage (All others to GND)	Vmin	−0.3	V
Maximum Voltage (IN to GND)	$Vmax_{IN}$	29	V
Maximum Voltage (OVLO to GND)	$Vmax_{OVLO}$	14	V
Maximum Voltage (OUT to GND)	$Vmax_{OUT}$	22	V
Maximum Voltage (All others to GND)	Vmax	7	V
Maximum DC current	Imax	4.5	A
Peak input current	Ipeak	8	A
Thermal Resistance, Junction−to−Air	$R_{\theta JA}$	70	°C/W
Operating Ambient Temperature Range	T_A	−40 to +85	°C
Storage Temperature Range	T_{stg}	−65 to +150	°C
Junction Operating temperature	T_J	+ 125	°C
ESD Withstand Voltage (IEC 61000−4−2) Human Body Model (HBM), model = 2 (Note 1) Machine Model (MM) model = B (Note 2)	V_{esd}	15 kV air, 8 kV contact 2000 V 200 V	kV V V
Moisture Sensitivity	MSL	Level 1	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Human Body Model, 100 pF discharged through a 1.5 kΩ resistor following specification JESD22/A114.
2. Machine Model, 200 pF discharged through all pins following specification JESD22/A115

Table 3. ELECTRICAL CHARACTERISTICS
Min / Max limits values (–40°C < T_A < +85°C) and V_{in} = +5 V (Unless otherwise noted). Typical values are T_A = +25°C.

Characteristics	Symbols	Conditions		Min	Typ	Max	Unit
Input Voltage Range	V_{in}, V_{OVLO}			2.8		28	V
Under voltage Lockout	UVLO	V_{in} rising				2.8	V
Under voltage Lockout hysteresis	$UVLO_{hyst}$	V_{in} falling		–	60	–	mV
Internal Over voltage Lockout threshold	OVLO	V_{in} rising (Note 3) OVLO pin tied to GND – 25°C	NCP392CR	13.4	13.8	14.2	V
			NCP392CS	15	15.5	16	
Internal Over voltage Lockout hysteresis	$OVLO_{hyst}$	V_{in} falling (Note 3) OVLO pin tied to GND – 25°C		1.5		2.5	%
External OVLO Reference	$OVLO_{\_EXT}$		NCP392CR	1.12	1.20	1.24	V
			NCP392CS	1.18	1.221	1.26	
External Adjustable OVLO				4		20	V
Over–Voltage Lockout Hysteresis	$OVLO_{EXThyst}$	V_{in} falling			2		%
External OVLO select threshold	$OVLO_{SEL}$			0.2		0.3	V
Vin versus Vout Resistance	R_{DSon}	V_{in} = 5 V, $\overline{EN}$ = GND, –40°C < T_J < 125°C			34	50	mΩ
Supply Quiescent Current	I_{DD}	No load, $\overline{EN}$ = 0.4 V			58	100	μA
Standby Current	I_{STB}	No load, $\overline{EN}$ = 1.2 V,				6	μA
OVLO Supply current	I_{IN_OVLO}	V_{OVLO} = 3 V, V_{IN} = 5 V, V_{OUT} = 0 V			60	100	μA
OVLO select leakage	I_{OVLO}					100	nA
LOGIC							
$\overline{EN}$ Voltage High	V_{IH}			1.2			V
$\overline{EN}$ Voltage Low	V_{IL}					0.4	V
$\overline{ACOK}$ Output Low Voltage	V_{OL}	I_{SINK} = 1 mA			0.4		V
TIMINGS							
Start up time	t_{START}	From V_{in} > 2.8 V to 10% V_{out}, $\overline{EN}$ low			15		ms
Enable time	t_{EN}	V_{in} present, From $\overline{EN}$ high to low, 10% V_{out}			15		ms
Soft Start	t_{RISE}	From 10% to 90% of V_{out}, C load 100 μF, Rload, 100 Ω, $\overline{EN}$ low			1		ms
$\overline{ACOK}$ Start up time	t_{START2}	From Vin Valid to $\overline{ACOK}$ tied low, $\overline{EN}$ low or high			30		ms
Turn off time	t_{OFF}	Surge off time			100		ns
Disable time	t_{DIS}	From EN >1.2 V to 90% V_{out}. No load			20		μs
OVLO Turn off time	t_{OVLO}	V_{in} rising 2 V/μs			1.5		μs
TSD							
Thermal shutdown	TSD				140		°C
Thermal shutdown rearming	TSD rearm				115		°C

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Please contact your ON Semiconductor representative for additional OVLO threshold.
   Electrical parameters are guaranteed by correlation across the full range of temperature.

Operation

The NCP392C provides over−voltage protection for positive voltage surge, up to + 28 V. An additional clamp, between IN and GND, protects the part against surge test, in compliance with IEC 61000−4−5 standard.

A $\overline{\text{ACOK}}$ open drain fault indicator is provided. This signal indicates whether input voltage is within the valid range.

Under−voltage Lockout (UVLO)

To ensure proper operation under any conditions, the device has a built−in under−voltage lock out (UVLO) circuit. This circuit has a built−in hysteresis to provide noise immunity to transient conditions.

Over−voltage Lockout (OVLO)

To protect connected systems on Vout pin from over−voltage, the device has a built−in over−voltage lock out (OVLO) circuit. During over−voltage condition, the output remains disabled until the input voltage is above OVLO − hysteresis.

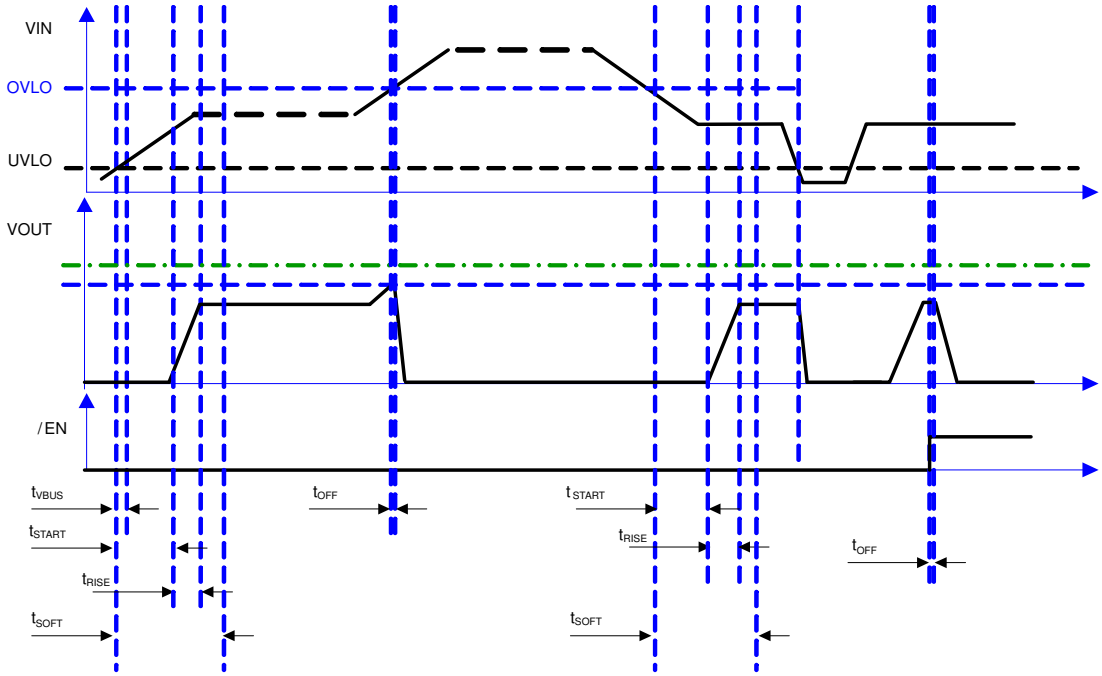


Figure 4. UVLO, OVLO and $\overline{\text{EN}}$ Functionality

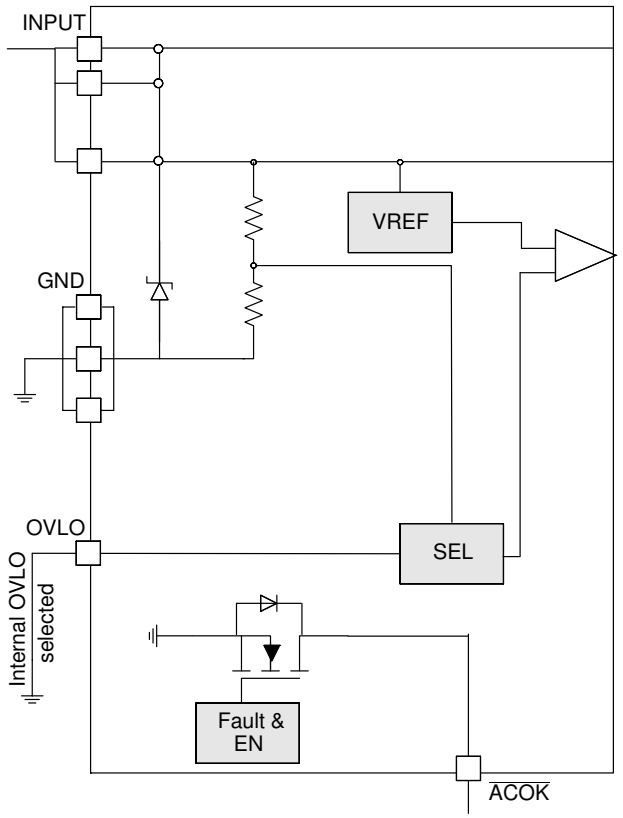


Figure 5. External Connection to GND of OVLO

If OVLO pin is not grounded, and by adding external bridge resistor on OVLO pin, between IN and GND, overvoltage protection can be adjusted as following:

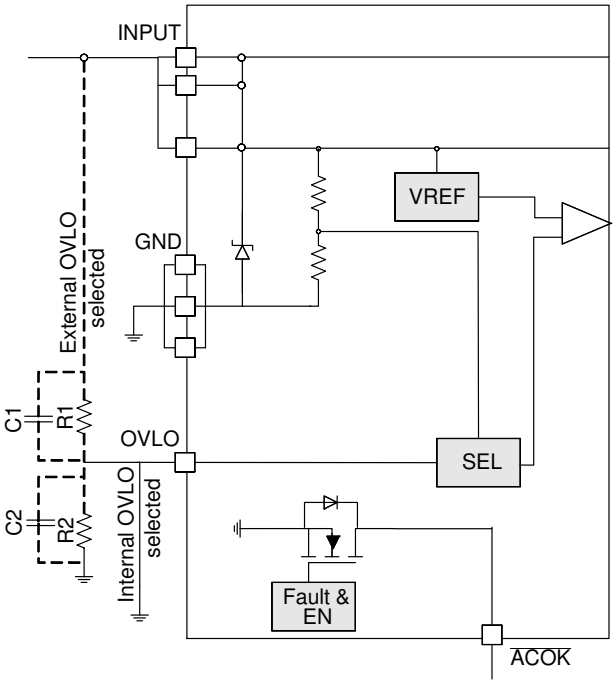


Figure 6. External Connection to Resistor Bridge of OVLO

$$NEW\_OVLO_{TH} = \frac{OVLO_{EXT} \times (R_1 + R_2)}{R_2} \quad \text{(eq. 1)}$$

With: $OVLO_{EXT}$ = 1.221 V Typical (OVLO External Reference)

Example:
NEW_OVLO_{TH} target 12 V.

$$R1 = R2 \times \left(\frac{OVLO}{1.221} - 1\right) = R2 \times \left(\frac{12}{1.221} - 1\right) = 8.828 \times R2 \quad \text{(eq. 2)}$$

Taking into account external input bridge doesn't have excessive current consumption, and 1% is recommended:

R2 arbitrarilly fixed at 1.05 MΩ.
R1 = 9.269 MΩ (9.31 MΩ standard value)
Obtained typical OVLO = 12.04 V

C_1 and C_2 should be selected in such a way that the time constant $R_1C_1 = R_2C_2$.

$\overline{EN}$ Input

To enable normal operation, the $\overline{EN}$ pin has to be at low level. There is neither internal pull up, nor internal pull down connected to $\overline{EN}$ pin. If not externally driven, this pin and so NCP392C switch are undefined state.

A high level on the pin, disconnects OUT pin from IN pin.

Table 4. CONTROL LOGIC MODES

OVP State NCP392Cx		OVLO EXT	
		Low	High
$\overline{EN}$	Low	ON T_{start} 15 ms	OFF
	High	OFF	OFF

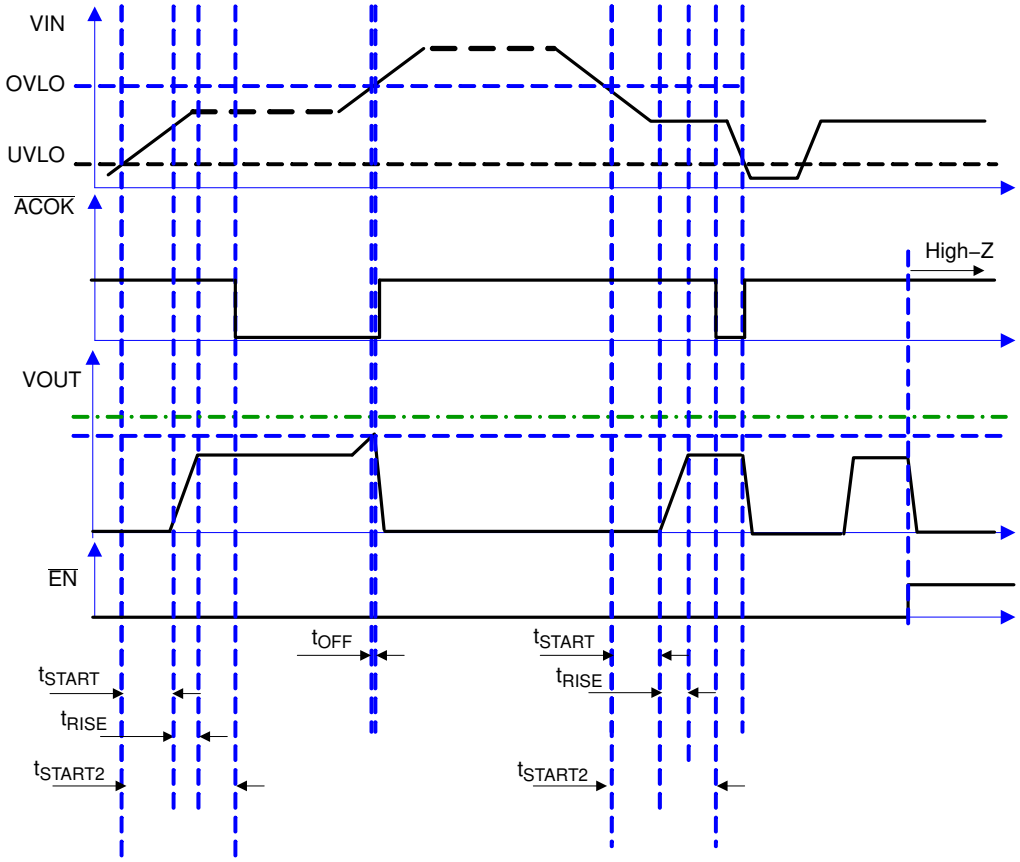


Figure 7. $\overline{\text{EN}}$ and $\overline{\text{ACOK}}$ Associated Timers

$\overline{\text{ACOK}}$ Pin

The NCP392C version integrates a $\overline{\text{ACOK}}$ status indicator. This is a drain pin tied low when no fault is present (no TSd, no under voltage, no over voltage).

When disabled, the $\overline{\text{ACOK}}$ feature is disabled too and the output pin is in high impedance mode.

Thermal Shutdown Protection

In case of internal overheating, the integrated thermal shutdown (TSD) protection allows to open the internal MOSFET in order to instantaneously decrease the device temperature.

Embedded hysteresis allows to reengage the MOSFET when the junction temperature decreases.

If the fault event is still present, the temperature increases again and engages the thermal shutdown one more time until fault event disappeared.

PCB Recommendations

To limit internal power dissipation, PCB routing must be carefully done to improve current capability.

The NCP392C is declined in a CSP package. So power dissipation can be decreased on each pin connection but main thermal area must be as large as possible around IN and OUT pins. Taking into account and respectively, four IN and OUT pins must be hardwired together on the PCB.

Maximum power dissipation can be calculated with the following formula:

$$T_J - T_A = R_{\theta JA} \times P_d \qquad \text{(eq. 3)}$$

T_J: junction temperature
T_A: ambient temperature
$R_{\theta JA}$: thermal resistance of the junction to air through the case and board.
P_d: power dissipation = $R_{DS(on)}$ x I^2

ESD Tests

The NCP392C fully supports the IEC61000−4−2, level 4 (Input pin, 1 μF mounted on board).

That means, in Air condition, V_{in} has a ±15 kV ESD protected input. In Contact condition, V_{in} has ±8 kV ESD protected input.

Please refer to Figure 8 to see the IEC 61000−4−2 electrostatic discharge waveform.

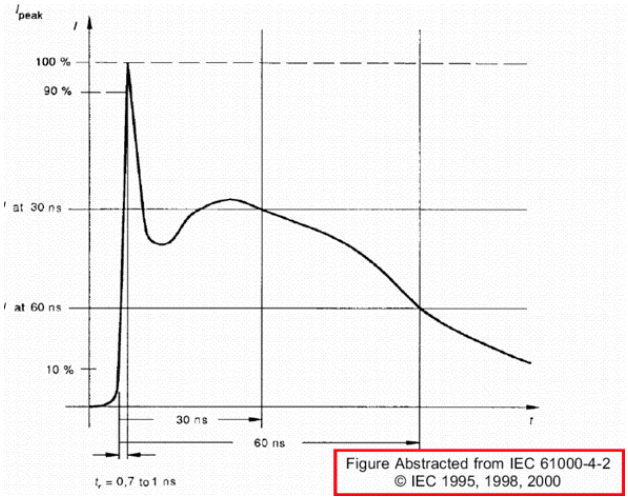


Figure 8. I_{peak} = f(t) / IEC61000−4−2

USB OTG Support

When used in an application that has to supply voltage to an external accessory (i.e. USB OTG), the part is able to supply 1.8 A to the accessory. If V_{IN} = 0 V when +5.0 V OTG is applied to the OUT pin, current will flow through the MOSFET body diode and, as soon as the output voltage will be higher than the V_{UVLO} voltage (2.8 V) plus Body diode forward voltage, the part will turn fully ON and current will be supplied to the accessory with minimum drop.

In that case, the $\overline{\text{ACOK}}$ pin will keep High−Z state.

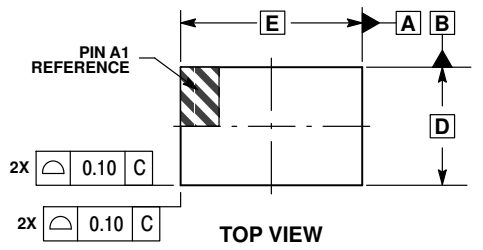
ORDERING INFORMATION

Device	Marking	Option	Package	Shipping†
NCP392CRFCCT1G	392CR	OVLO 13.8 V	WLCSP (Pb−Free)	3000 / Tape & Reel
NCP392CSFCCT1G	392CS	OVLO 15.5 V		

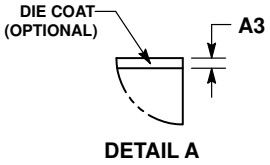
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

WLCSP12, 1.3x2.0
CASE 567JM
ISSUE A



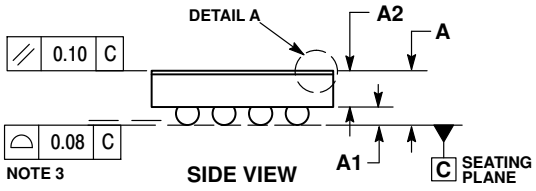
TOP VIEW



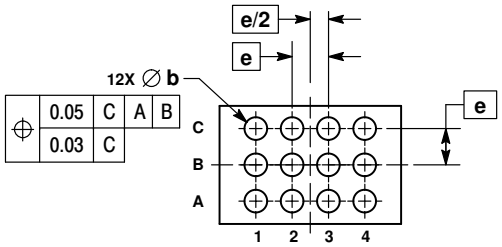
DETAIL A

NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. COPLANARITY APPLIES TO SPHERICAL CROWNS OF SOLDER BALLS.

	MILLIMETERS	
DIM	MIN	MAX
A	–––	0.60
A1	0.17	0.23
A2	0.36 REF	
A3	0.04 REF	
b	0.24	0.30
D	1.26	1.31
E	2.01	2.04
e	0.40 BSC	

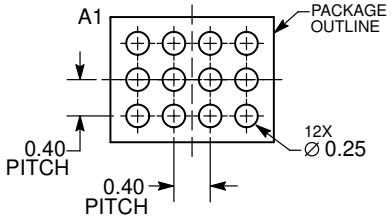


SIDE VIEW



BOTTOM VIEW

RECOMMENDED SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PUBLICATION ORDERING INFORMATION

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